



## TPS2513A-Q1, TPS2514A-Q1 USB Dedicated Charging Port Controller

### 1 Features

- AEC-Q100 Qualified:
  - Device HBM ESD Classification Level H2
  - Device CDM ESD Classification Level C5
- Automatically Selects Charge Mode
  - D+ and D- Divider Mode 2.7 V and 2.7 V
  - D+ and D- 1.2 V Mode
  - D+ and D- Shorted Mode per USB Battery Charging Specification, Revision 1.2 (BC1.2)
- Operating Range: 4.5 V to 5.5 V
- Dual USB Charging Port Controller, TPS2513A-Q1
- Single USB Charging Port Controller, TPS2514A-Q1
- Available in SOT23-6 Package

### 2 Applications

- Automotive USB Power Charger
- Car Charger

### 3 Description

The TPS2513A-Q1 and TPS2514A-Q1 are USB dedicated charging port (DCP) controllers, used for the charging of most popular mobile phones and tablets. An auto-detect feature monitors USB data line voltage, and automatically provides the correct electrical signatures on the data lines to charge compliant devices among the following dedicated charging schemes:

- Divider 3 mode, required to apply 2.7 V and 2.7 V on the D+ and D- Lines respectively
- BC1.2 shorted mode, required to short the D+ Line to the D- Line
- 1.2 V mode, required to apply 1.2 V on the D+ and D- Lines

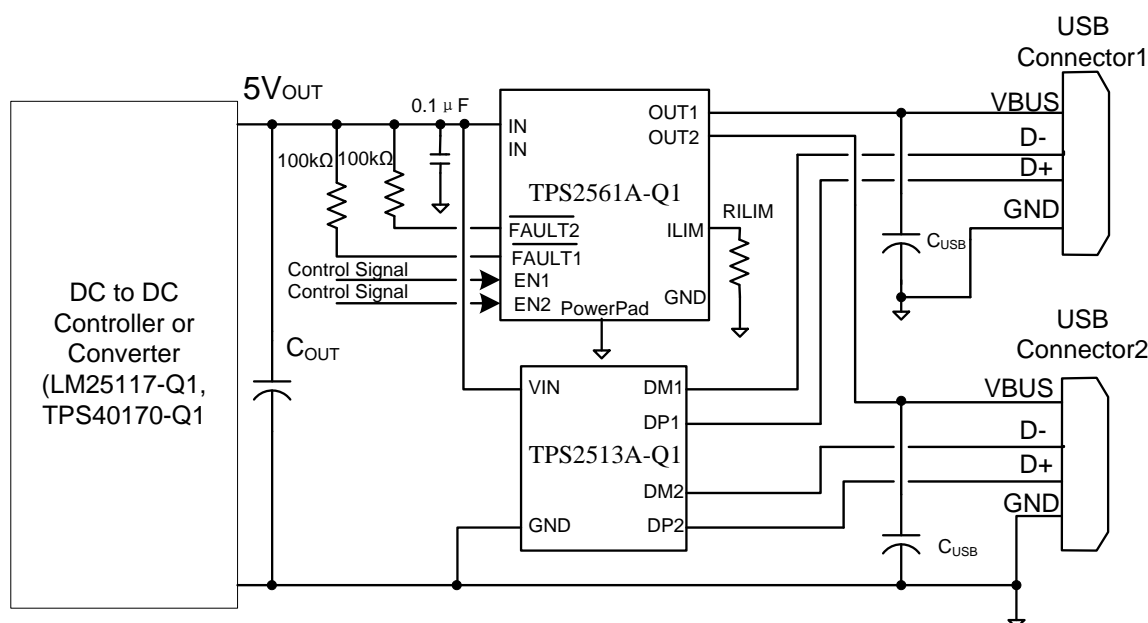
Use with the TPS2561A-Q1 and TPS2513A-Q1 (dual channel), TPS2557-Q1 and TPS2514A-Q1 (single channel) for low loss, automotive qualified, USB Charging Port Solution capable of charging all of today's popular phones and tablets.

#### Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS2513A-Q1	SOT-23 (6)	2.90mm x 1.60mm
TPS2514A-Q1		

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### 4 Simplified Application Diagram



Typical Application as USB Dedicated Charging Port Controller of Dual Port Automotive USB Charge Port Solution



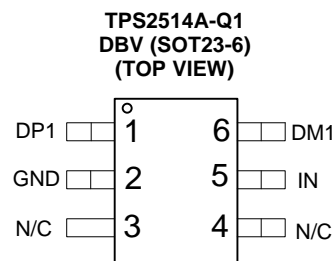
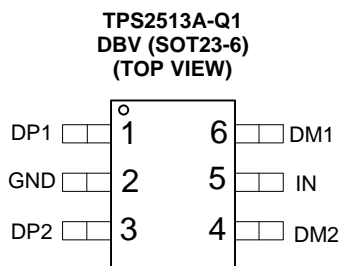
## Table of Contents

<b>1 Features</b> .....	<b>1</b>	8.3 Feature Description .....	<b>9</b>
<b>2 Applications</b> .....	<b>1</b>	8.4 Device Functional Modes .....	<b>11</b>
<b>3 Description</b> .....	<b>1</b>	<b>9 Applications and Implementation</b> .....	<b>12</b>
<b>4 Simplified Application Diagram</b> .....	<b>1</b>	9.1 Application Information .....	<b>12</b>
<b>5 Revision History</b> .....	<b>2</b>	9.2 Typical Application .....	<b>12</b>
<b>6 Pin Configuration and Functions</b> .....	<b>3</b>	<b>10 Power Supply Recommendations</b> .....	<b>13</b>
<b>7 Specifications</b> .....	<b>4</b>	<b>11 Layout</b> .....	<b>14</b>
7.1 Absolute Maximum Ratings .....	<b>4</b>	11.1 Layout Guidelines .....	<b>14</b>
7.2 ESD Ratings .....	<b>4</b>	11.2 Layout Example .....	<b>14</b>
7.3 Recommended Operating Conditions .....	<b>4</b>	<b>12 Device and Documentation Support</b> .....	<b>15</b>
7.4 Thermal Information .....	<b>4</b>	12.1 Related Links .....	<b>15</b>
7.5 Electrical Characteristics .....	<b>5</b>	12.2 Trademarks .....	<b>15</b>
7.6 Typical Characteristics .....	<b>6</b>	12.3 Electrostatic Discharge Caution .....	<b>15</b>
<b>8 Detailed Description</b> .....	<b>7</b>	12.4 Glossary .....	<b>15</b>
8.1 Overview .....	<b>7</b>	<b>13 Mechanical, Packaging, and Orderable Information</b> .....	<b>15</b>
8.2 Functional Block Diagram .....	<b>8</b>		

## 5 Revision History

Changes from Original (May 2014) to Revision A	Page
• Added device TPA2514A-Q1 to the datasheet .....	<b>1</b>
• Changed Feature From: Dual USB Port Controller To: Dual USB Charging Port Controller, TPS2513A-Q1 .....	<b>1</b>
• Added Feature "Single USB Charging Port Controller, TPS2514A-Q1 .....	<b>1</b>
• Changed the Description text From: "Use with the TPS2561A-Q1 for a low loss, .." To: "Use with the TPS2561A-Q1 and TPS2513A-Q1 (dual channel), TPS2557-Q1 and TPS2514A-Q1 (single channel) for low loss,.." .....	<b>1</b>
• Changed the BODY SIZE (NOM) values in the <i>Device Information</i> table .....	<b>1</b>
• Added the TPS2514A-Q1 pin out image and table .....	<b>3</b>
• Changed the Handling Ratings table to the <a href="#">ESD Ratings</a> table .....	<b>4</b>
• Added <a href="#">Figure 5</a> .....	<b>8</b>
• Changed list item in <a href="#">Layout Guidelines</a> "When USB power switch is used,.." .....	<b>14</b>
• Changed list item in <a href="#">Layout Guidelines</a> "Regarding TPS2561A-Q1 layout guidelines,.." .....	<b>14</b>

## 6 Pin Configuration and Functions



### Pin Functions, TPS2513A-Q1

NO.	NAME	TYPE <sup>(1)</sup>	DESCRIPTION
1	DP1	I/O	Connected to the D+ line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.
2	GND	G	Ground connection
3	DP2	I/O	Connected to the D+ line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.
4	DM2	I/O	Connected to the D– line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.
5	IN	P	Power supply. Connect a ceramic capacitor with a value of 0.1-μF or greater from the IN pin to GND as close to the device as possible.
6	DM1	I/O	Connected to the D– line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.

(1) G = Ground, I = Input, O = Output, P = Power

### Pin Functions, TPS2514A-Q1

NO.	NAME	TYPE <sup>(1)</sup>	DESCRIPTION
1	DP1	I/O	Connected to the D+ line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.
2	GND	G	Ground connection
3	N/C	–	No connect pin, can be grounded or left floating.
4	N/C	–	No connect pin, can be grounded or left floating
5	IN	P	Power supply. Connect a ceramic capacitor with a value of 0.1-μF or greater from the IN pin to GND as close to the device as possible.
6	DM1	I/O	Connected to the D– line of USB connector, provide the correct voltage with attached portable equipment for DCP detection.

(1) G = Ground, I = Input, O = Output, P = Power

## 7 Specifications

### 7.1 Absolute Maximum Ratings<sup>(1)</sup>

Over recommended junction temperature range, voltages are referenced to GND (unless otherwise noted)

		MIN	MAX	UNIT
Voltage range	IN	–0.3	7	V
	DP1, DP2 output voltage, DM1, DM2 output voltage	–0.3	5.8	
	DP1, DP2 input voltage, DM1, DM2 input voltage	–0.3	5.8	
Continuous output sink current	DP1, DP2 input current, DM1, DM2 input current		35	mA
Continuous output source current	DP1, DP2 output current, DM1, DM2 output current		35	mA
Operating Junction Temperature, $T_J$		–40	125	°C
Storage temperature range, $T_{stg}$		–65	150	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup>	±2000	V
	Charged-device model (CDM), per AEC Q100-011	±750	

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 7.3 Recommended Operating Conditions

Voltages are referenced to GND (unless otherwise noted), positive current are into pins.

		MIN	MAX	UNIT
$V_{IN}$	Input voltage of IN	4.5	5.5	V
$V_{(DP1)}$	DP1 data line input voltage	0	5.5	V
$V_{(DM1)}$	DM1 data line input voltage	0	5.5	V
$I_{(DP1)}$	Continuous sink or source current		±10	mA
$I_{(DM1)}$	Continuous sink or source current		±10	mA
$V_{DP2}$	DP2 data line input voltage	0	5.5	V
$V_{(DM2)}$	DM2 data line input voltage	0	5.5	V
$I_{(DP2)}$	Continuous sink or source current		±10	mA
$I_{(DM2)}$	Continuous sink or source current		±10	mA
$T_J$	Operating junction temperature	–40	125	°C

### 7.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	DBV (6 PINS)	UNITS
$R_{\theta JA}$	Junction-to-ambient thermal resistance	179.9	°C/W
$R_{\theta JCTop}$	Junction-to-case (top) thermal resistance	117.5	
$R_{\theta JB}$	Junction-to-board thermal resistance	41.9	
$\Psi_{JT}$	Junction-to-top characterization parameter	17.2	
$\Psi_{JB}$	Junction-to-board characterization parameter	41.5	
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance	N/A	

- (1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, [SPRA953](#).

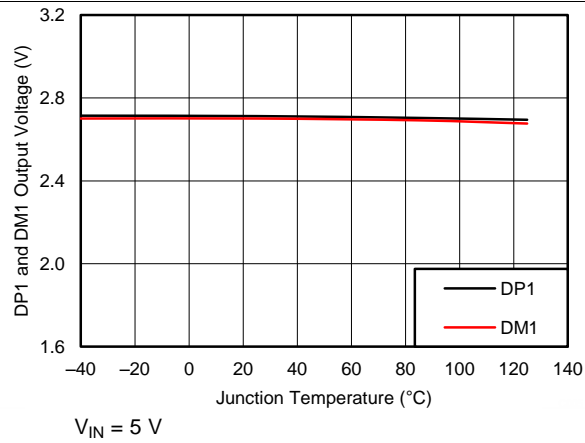
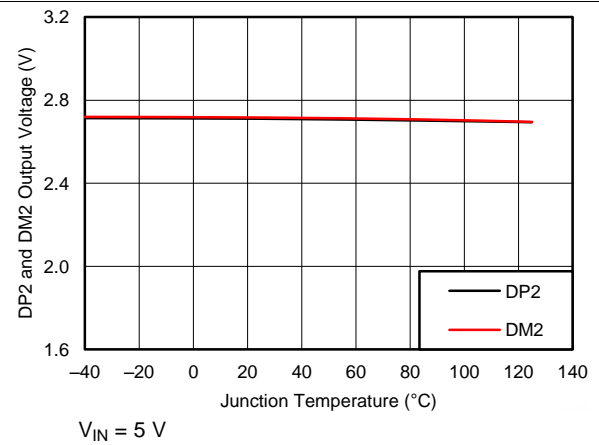
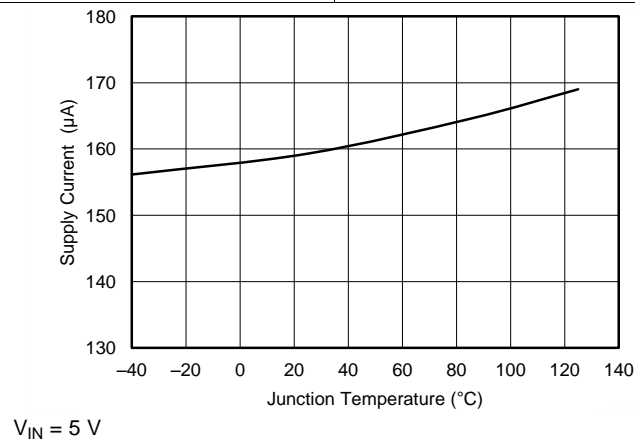
## 7.5 Electrical Characteristics

Conditions are  $-40^{\circ}\text{C} \leq (T_J = T_A) \leq 125^{\circ}\text{C}$ ,  $4.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ . Positive current are into pins. Typical values are at  $25^{\circ}\text{C}$ . All voltages are with respect to GND (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>UNDERVOLTAGE LOCKOUT</b>						
$V_{UVLO}$	IN rising UVLO threshold voltage		3.9	4.1	4.3	V
	Hysteresis <sup>(1)</sup>			100		mV
<b>SUPPLY CURRENT</b>						
$I_{IN}$	IN supply current	$4.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$		155	220	$\mu\text{A}$
<b>BC 1.2 DCP MODE (SHORT MODE)</b>						
$R_{(DPM\_SHORT1)}$	DP1 and DM1 shorting resistance	$V_{DP1} = 0.8\text{ V}$ , $I_{DM1} = 1\text{ mA}$		157	200	$\Omega$
$R_{(DCHG\_SHORT1)}$	Resistance between DP1/DM1 and GND	$V_{DP1} = 0.8\text{ V}$	350	656	1150	k $\Omega$
$V_{(DPL\_TH\_DETACH1)}$	Voltage threshold on DP1 under which the device goes back to divider mode		310	330	350	mV
$V_{(DPL\_TH\_DETACH\_HYS1)}$	Hysteresis <sup>(1)</sup>			50		mV
$R_{(DPM\_SHORT2)}$	DP2 and DM2 shorting resistance	$V_{DP2} = 0.8\text{ V}$ , $I_{DM2} = 1\text{ mA}$		157	200	$\Omega$
$R_{(DCHG\_SHORT2)}$	Resistance between DP2/DM2 and GND	$V_{DP2} = 0.8\text{ V}$	350	656	1150	k $\Omega$
$V_{(DPL\_TH\_DETACH2)}$	Voltage threshold on DP2 under which the device goes back to divider mode		310	330	350	mV
$V_{(DPL\_TH\_DETACH\_HYS2)}$	Hysteresis <sup>(1)</sup>			50		mV
<b>DIVIDER MODE</b>						
$V_{(DP1\_2.7V)}$	DP1 output voltage	$V_{IN} = 5\text{ V}$	2.57	2.7	2.84	V
$V_{(DM1\_2.7V)}$	DM1 output voltage	$V_{IN} = 5\text{ V}$	2.57	2.7	2.84	V
$R_{(DP1\_PAD1)}$	DP1 output impedance	$I_{DP1} = -5\text{ }\mu\text{A}$	24	30	36	k $\Omega$
$R_{(DM1\_PAD1)}$	DM1 output impedance	$I_{DM1} = -5\text{ }\mu\text{A}$	24	30	36	k $\Omega$
$V_{(DP2\_2.7V)}$	DP2 output voltage	$V_{IN} = 5\text{ V}$	2.57	2.7	2.84	V
$V_{(DM2\_2.7V)}$	DM2 output voltage	$V_{IN} = 5\text{ V}$	2.57	2.7	2.84	V
$R_{(DP2\_PAD1)}$	DP2 output impedance	$I_{DP2} = -5\text{ }\mu\text{A}$	24	30	36	k $\Omega$
$R_{(DM2\_PAD1)}$	DM2 output impedance	$I_{DM2} = -5\text{ }\mu\text{A}$	24	30	36	k $\Omega$
<b>1.2 V / 1.2 V MODE</b>						
$V_{(DP1\_1.2V)}$	DP1 output voltage	$V_{IN} = 5\text{ V}$	1.12	1.2	1.28	V
$V_{(DM1\_1.2V)}$	DM1 output voltage	$V_{IN} = 5\text{ V}$	1.12	1.2	1.28	V
$R_{(DM1\_PAD2)}$	DP1 output impedance	$I_{DP1} = -5\text{ }\mu\text{A}$	80	102	130	k $\Omega$
$R_{(DP1\_PAD2)}$	DM1 output impedance	$I_{DM1} = -5\text{ }\mu\text{A}$	80	102	130	k $\Omega$
$V_{(DP2\_1.2V)}$	DP2 output voltage	$V_{IN} = 5\text{ V}$	1.12	1.2	1.28	V
$V_{(DM2\_1.2V)}$	DM2 output voltage	$V_{IN} = 5\text{ V}$	1.12	1.2	1.28	V
$R_{(DP2\_PAD2)}$	DP2 output impedance	$I_{DP2} = -5\text{ }\mu\text{A}$	80	102	130	k $\Omega$
$R_{(DM2\_PAD2)}$	DM2 output impedance	$I_{DM2} = -5\text{ }\mu\text{A}$	80	102	130	k $\Omega$

(1) Parameters provided for reference only, and do not constitute part of TI's published device specifications for purposes of TI's product warranty

## 7.6 Typical Characteristics


**Figure 1. DP1 and DM1 Output Voltage vs Temperature**

**Figure 2. DP2 and DM2 Output Voltage vs Temperature**

**Figure 3. Supply Current vs Temperature**

## 8 Detailed Description

### 8.1 Overview

TPS2513A-Q1 and TPS2514A-Q1 are dedicated charging port controllers, used for the charging of most popular mobile phones and tablets.

The following overview references various industry standards. It is always recommended to consult the latest standard to ensure the most recent and accurate information.

Rechargeable portable equipment requires an external power source to charge its batteries. USB ports are convenient locations for charging because of an available 5-V power source. Universally accepted standards are required to ensure host and client-side devices meet the power management requirements. Traditionally, USB host ports following the USB 2.0 Specification must provide at least 500 mA to downstream client-side devices. Because multiple USB devices can be attached to a single USB port through a bus-powered hub, it is the responsibility of the client-side device to negotiate the power allotment from the host to guarantee the total current draw does not exceed 500 mA. In general, each USB device can subsequently request more current, which is granted in steps of 100 mA up 500 mA total. The host may grant or deny the request based on the available current.

Additionally, the success of the USB technology makes the micro-USB connector a popular choice for wall adapter cables. This allows a portable device to charge from both a wall adapter and USB port with only one connector.

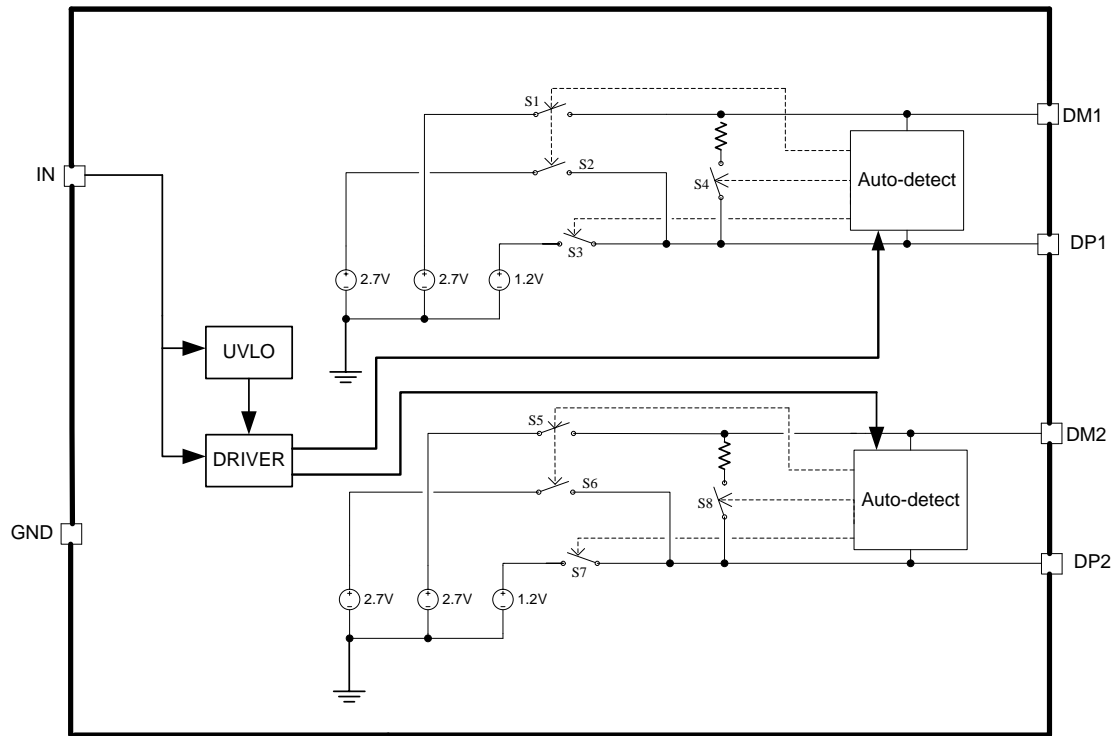
One common difficulty has resulted from this. As USB charging has gained popularity, the 500-mA minimum defined by the USB 2.0 Specification or 900 mA defined in the USB 3.0 Specification, has become insufficient for many handsets, tablets and personal media players (PMP) which have a higher rated charging current. Wall adapters and car chargers can provide much more current than 500 mA or 900 mA to fast charge portable devices. Several new standards have been introduced defining protocol handshaking methods that allow host and client devices to acknowledge and draw additional current beyond the 500 mA (defined in the USB 2.0 Specification) or 900 mA (defined in the USB 3.0 Specification) minimum while using a single micro-USB input connector.

## TPS2513A-Q1, TPS2514A-Q1

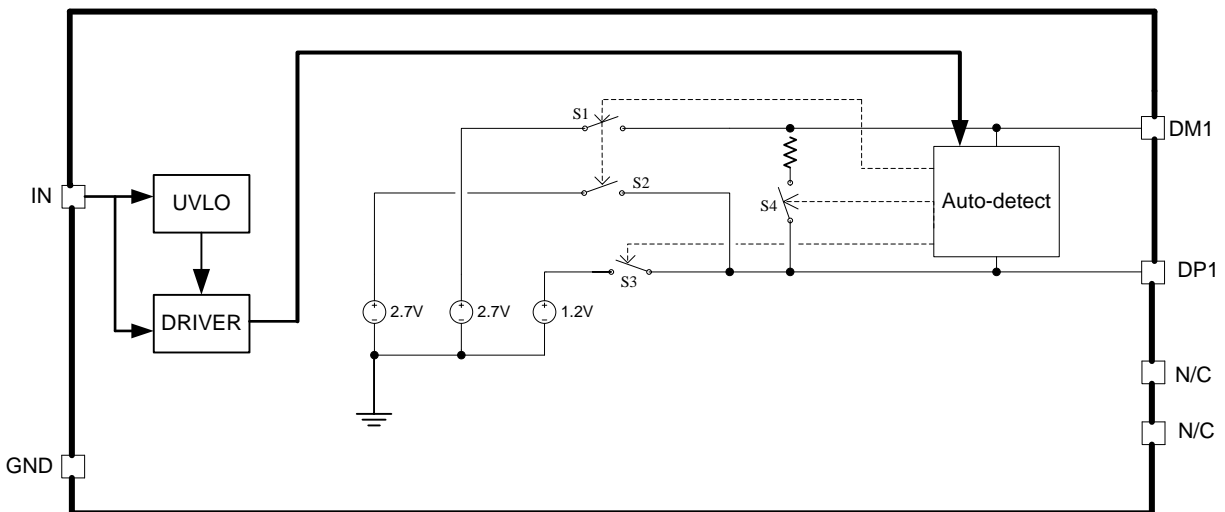
SLVSCC8A – MAY 2014 – REVISED DECEMBER 2014

[www.ti.com](http://www.ti.com)

### 8.2 Functional Block Diagram



**Figure 4. TPS2513A-Q1 Functional Block Diagram**



**Figure 5. TPS2514A-Q1 Functional Block Diagram**



## 8.3 Feature Description

### 8.3.1 BC1.2

TPS2513A-Q1 and TPS2514A-Q1 support four of the most common protocols:

- USB Battery Charging Specification, Revision 1.2 (BC1.2)
- Chinese Telecommunications Industry Standard YD/T 1591-2009
- Divider Mode
- 1.2 V Mode

YD/T 1591-2009 is a subset of the BC1.2 specification supported by the vast majority of devices that implement USB charging. Divider and 1.2-V charging schemes are supported in devices from specific yet popular device makers. BC1.2 has three different port types, listed as follows.

- Standard downstream port (SDP)
- Charging downstream port (CDP)
- Dedicated charging port (DCP)

The BC1.2 Specification defines a charging port as a downstream facing USB port that provides power for charging portable equipment.

[Table 1](#) shows different port operating modes according to the BC1.2 Specification.

**Table 1. Operating Modes Table**

PORT TYPE	SUPPORTS USB2.0 COMMUNICATION	MAXIMUM ALLOWABLE CURRENT DRAWN BY PORTABLE EQUIPMENT (A)
SDP (USB 2.0)	Yes	0.5
SDP (USB 3.0)	Yes	0.9
CDP	Yes	1.5
DCP	No	1.5

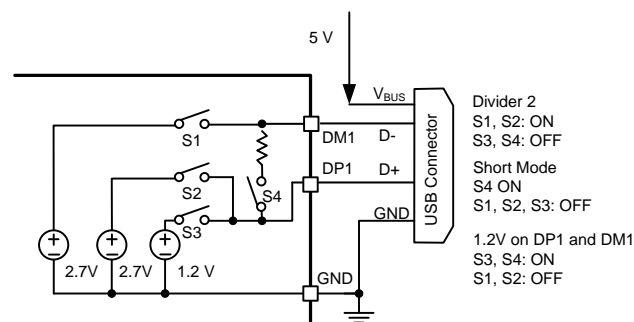
The BC1.2 Specification defines the protocol necessary to allow portable equipment to determine what type of port it is connected to so that it can allot its maximum allowable current drawn. The hand-shaking process is two steps. During step one, the primary detection, the portable equipment outputs a nominal 0.6 V output on its D+ line and reads the voltage input on its D– line. The portable device concludes it is connected to a SDP if the voltage is less than the nominal data detect voltage of 0.3 V. The portable device concludes that it is connected to a Charging Port if the D– voltage is greater than the nominal data detect voltage of 0.3V and less than 0.8 V. The second step, the secondary detection, is necessary for portable equipment to determine between a CDP and a DCP. The portable device outputs a nominal 0.6 V output on its D– line and reads the voltage input on its D+ line. The portable device concludes it is connected to a CDP if the data line being remains is less than the nominal data detect voltage of 0.3 V. The portable device concludes it is connected to a DCP if the data line being read is greater than the nominal data detect voltage of 0.3 V and less than 0.8 V.

### 8.3.2 Undervoltage Lockout (UVLO)

The undervoltage lockout (UVLO) circuit disables DP1, DM1, DP2 and DM2 output voltage until the input voltage reaches the UVLO turn-on threshold. Built-in hysteresis prevents unwanted oscillations due to input voltage drop from large current surges.

### 8.3.3 DCP Auto-Detect

TPS2513A-Q1 and TPS2514A-Q1 integrate an auto-detect feature to support Divider 3 mode, shorted mode and 1.2 V modes. If a divider device is attached, 2.7 V is applied to the DP pin and 2.7 V is applied to the DM pin. If a BC1.2-compliant device is attached, the TPS251xA-Q1 automatically switches into shorted mode. If a device compliant with the 1.2 V / 1.2 V charging scheme is attached, 1.2 V is applied on both the DP pin and the DM pin. The functional diagram of DCP auto-detect feature (DM1 and DP1) is shown in Figure 6. DCP auto-detect feature (DM2 and DP2) has the same functional configuration.



**Figure 6. DCP Auto-Detect Functional Diagram**

## 8.4 Device Functional Modes

### 8.4.1 Shorted Mode

The USB BC1.2 Specification and the Chinese Telecommunications Industry Standard YD/T 1591-2009 specify that the D+ and D– data lines should be shorted together with a maximum series impedance of 200  $\Omega$ . This is shown in [Figure 7](#).

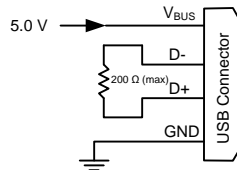


Figure 7. Shorted Mode

### 8.4.2 Divider Mode

There are three charging schemes for divider mode. They are named after Divider 1, Divider 2, and Divider 3 that are shown in [Figure 8](#), [Figure 9](#), and [Figure 10](#). The Divider 1 charging scheme is used for 5-W adapters, and applies 2 V to the D+ line and 2.7 V to the D– data line. The Divider 2 charging scheme is used for 10-W adapters, and applies 2.7 V on the D+ line and 2 V is applied on the D– line. The Divider 3 charging scheme is used for 12-W adapters, and applies 2.7 V on D+ and D– lines. TPS2513A-Q1 and TPS2514A-Q1 only integrate Divider 3 charging scheme.

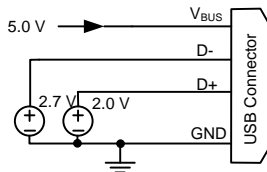


Figure 8. Divider 1

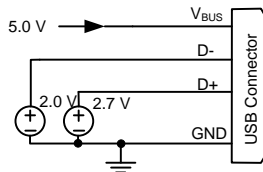


Figure 9. Divider 2

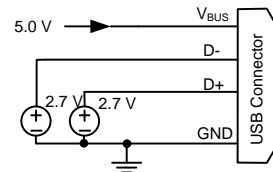


Figure 10. Divider 3

### 8.4.3 1.2 V Mode

As shown in [Figure 11](#), some tablet USB chargers require 1.2 V on the shorted data lines of the USB connector. The maximum resistance between the D+ line and the D– line is 200  $\Omega$ .

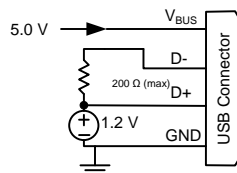


Figure 11. 1.2 V Mode

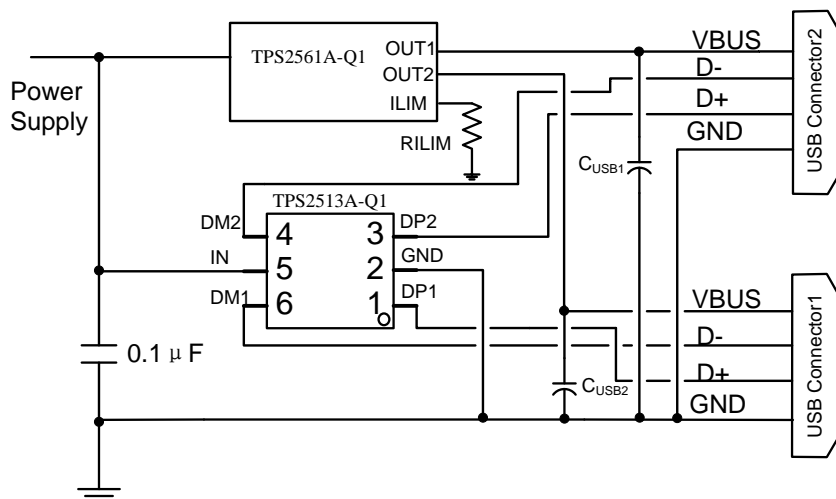
The device is a USB dedicated charging port (DCP) controllers. Applications include vehicle power charger, wall adapters with USB DCP and other USB chargers. The device DCP controllers have the auto-detect feature that monitors the D+ and D– line voltages of the USB connector, providing the correct electrical signatures on the DP and DM pins for the correct detections of compliant portable devices to fast charge. These portable devices include smart phones, 5-V tablets and personal media players.

## 9 Applications and Implementation

### 9.1 Application Information

The device is a dual channel USB charging port controller. It can be used for automotive USB charging port to support universal charging.

### 9.2 Typical Application



**Figure 12. Typical Application Schematic, Dual Ports Charger**

#### 9.2.1 Design Requirements

For dual USB ports, request that both ports support fast charge portable device compatible with divider 3, 1.2 V, and BC1.2 shorted mode.

#### 9.2.2 Detailed Design Procedure

##### 9.2.2.1 USB Power Switch

Some chargers requests that the USB port have an overcurrent protection when short circuits are encountered, TPS2561A-Q1 ([SLVSCC6](#)) is recommended.

The TPS2513A-Q1 divider 3 mode can support a maximum charging current up to 2.4 A.

When set, the TPS2561A-Q1 current limit ( $R_{ILIM}$ ) should keep each channel current limit above 2.4 A. For the correct current limit setting, refer to the TPS2561A-Q1 data sheet.

## Typical Application (continued)

### 9.2.3 Application Curves

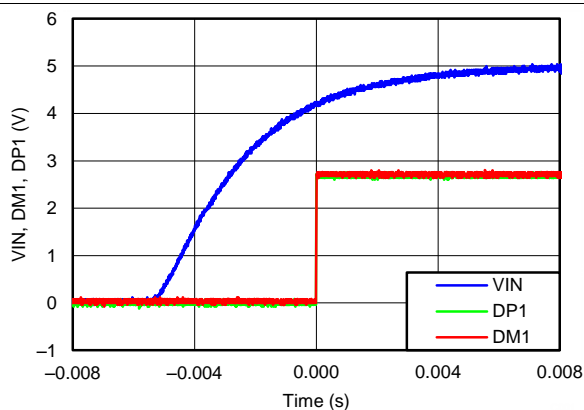


Figure 13. Power On (DM1 and DP1)

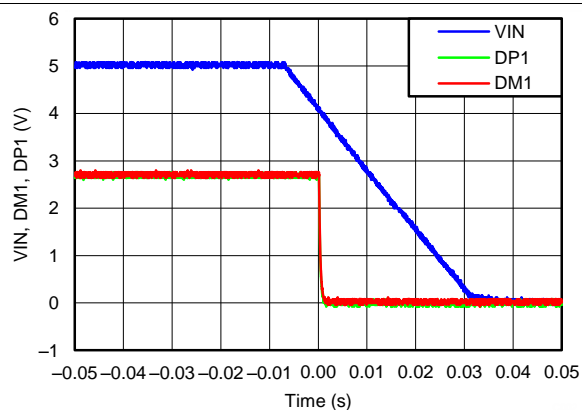


Figure 14. Power Off (DM1 and DP1)

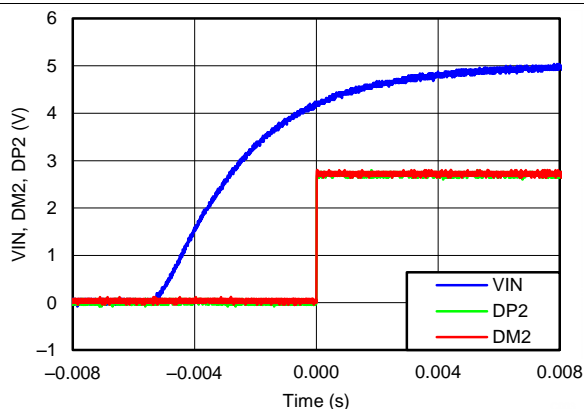


Figure 15. Power On (DM2 and DP2)

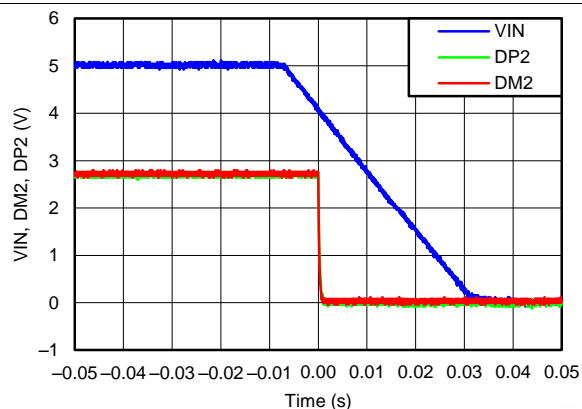


Figure 16. Power Off (DM2 and DP2)

## 10 Power Supply Recommendations

The devices only provide the correct electrical signatures on the data line of USB charger port and do not provide any power for the  $V_{BUS}$ . If a USB power switch is needed as an overcurrent protector, the TPS2561A-Q1 (SLVSCC6) is recommend.

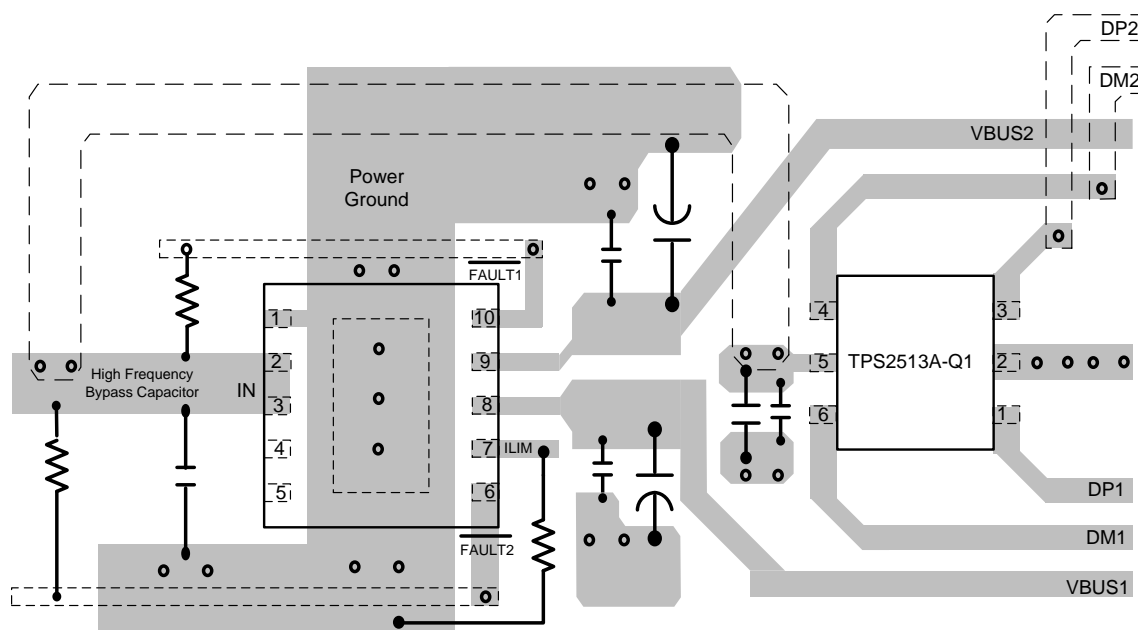
## 11 Layout

### 11.1 Layout Guidelines

- For all applications, a 0.1- $\mu$ F or greater ceramic bypass capacitor between IN and GND is recommended as close to the device as possible for local noise decoupling.
- When USB power switch is used, recommend connect TPS2513A-Q1 and TPS2514A-Q1 IN pin together with USB power switch IN pin. For TPS2513A-Q1, Dual channel USB power switch recommend TPS2561A-Q1, for TPS2514A-Q1, single channel USB power switch recommend TPS2557-Q1.
- Regarding TPS2561A-Q1 layout guidelines, see the TPS2561A-Q1 data sheet ([SLVSCC6](#)). Regarding TPS2557-Q1 layout guidelines, see the TPS2557-Q1 data sheet ([SLVSC97](#)).
- DP1 and DM1 provide one charging port controller, DP2 and DM2 provide another one charging port controller, when routing the trace, need consider the matching between DP and DM.

### 11.2 Layout Example

- VIA to Power Ground Plane



## 12 Device and Documentation Support

### 12.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
TPS2513A-Q1	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>
TPS2514A-Q1	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>	<a href="#">Click here</a>

### 12.2 Trademarks

All trademarks are the property of their respective owners.

### 12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TPS2513AQDBVRQ1</a>	Active	Production	SOT-23 (DBV)   6	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	PB6Q
TPS2513AQDBVRQ1.A	Active	Production	SOT-23 (DBV)   6	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	PB6Q
<a href="#">TPS2513AQDBVTQ1</a>	Active	Production	SOT-23 (DBV)   6	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	PB6Q
TPS2513AQDBVTQ1.A	Active	Production	SOT-23 (DBV)   6	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	PB6Q
<a href="#">TPS2514AQDBVRQ1</a>	Active	Production	SOT-23 (DBV)   6	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBAW
TPS2514AQDBVRQ1.A	Active	Production	SOT-23 (DBV)   6	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBAW
<a href="#">TPS2514AQDBVTQ1</a>	Active	Production	SOT-23 (DBV)   6	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBAW
TPS2514AQDBVTQ1.A	Active	Production	SOT-23 (DBV)   6	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	ZBAW

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.



In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF TPS2513A-Q1, TPS2514A-Q1 :**

- Catalog : [TPS2513A](#), [TPS2514A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS2513AQDBVRQ1	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS2513AQDBVTQ1	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS2514AQDBVRQ1	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS2514AQDBVTQ1	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS2513AQDBVRQ1	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS2513AQDBVTQ1	SOT-23	DBV	6	250	180.0	180.0	18.0
TPS2514AQDBVRQ1	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS2514AQDBVTQ1	SOT-23	DBV	6	250	180.0	180.0	18.0



## SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.

# EXAMPLE BOARD LAYOUT

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214840/G 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214840/G 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated